19-0492; Rev 0; 10/05 EVALUATION KIT AVAILABLE



450MHz CDMA/OFDM LNA/Mixer

General Description

The MAX2335 RF front-end receiver IC is designed for CDMA and OFDM applications in the 450MHz band.

The MAX2335 includes a low-noise amplifier (LNA) with adjustable IIP3 to minimize desensitization due to cross-modulation in the presence of a large interfering signal.

The mixer features differential IF outputs and is designed for high linearity and low noise, which is well suited for CDMA and OFDM applications.

An on-chip frequency divider is included to allow the use of a standard 1GHz VCO. Alternatively, the divider can be bypassed for use with a lower-frequency VCO.

The MAX2335 is available in a 28-pin TQFN package with exposed paddle and is specified for the -40°C to +85°C extended temperature range. The device is also offered in a lead-free package.

_Features

- ♦ 1.5dB LNA Noise Figure
- 16dB LNA Gain
- 2.1dB Cascaded Noise Figure
- Adjustable LNA IIP3
- LO Output Buffer for Transmitter
- LO Frequency Divider
- Small 5mm x 5mm, 28-Pin (Lead-Free) TQFN Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX2335ETI	-40°C to +85°C	28 Thin QFN-EP* (5mm x 5mm)	T2855-3
MAX2335ETI+	-40°C to +85°C	28 Thin QFN-EP* (5mm x 5mm)	T2855+3

*EP = Exposed paddle.

+Denotes lead-free package.

Pin Configuration/ Functional Diagram



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

Applications

450MHz-Band, WCDMA, IS-95, IS-2000, OFDM, Wireless Data Links

ABSOLUTE MAXIMUM RATINGS

 $\label{eq:VCC} V_{CC} \mbox{ to GND}-0.3V \mbox{ to } +4.3V \\ \mbox{All Other Pins to GND}-0.3V \mbox{ to } (V_{CC} + 0.3V) \\ \mbox{AC Input Pins (LNAIN, LO_IN, MIXIN) to GND}1V \mbox{ Peak Continuous Power Dissipation } (T_A = +70^{\circ}C) \\ \mbox{ 28-Pin Thin QFN (derate 34.5mW/°C above } +70^{\circ}C)2.7W }$

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION! ESD SENSITIVE DEVICE

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +2.9V \text{ to } +3.3V, R_{BIAS} = 18k\Omega, R_{LNA} = 24k\Omega, BUFFEN = LOW, LO/2 = HIGH, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, unless otherwise noted.) Typical values are at V_{CC} = +2.9V, LOW = 0V, HIGH = +3.0V, T_A = +25^{\circ}C, unless otherwise noted.) (Note 1)$

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
		HGHL mode (MODE[2:0] = 111)		32	38	
Operating Supply Current	lcc	HGLL mode (MODE[2:0] = 101)		24	29	mA
		LG mode (MODE[2:0] = 011)		27	31	μA mA
Shutdown Supply Current	Icc	Shutdown mode (MODE[2:0] = 000)		0.2	10	μA
LO Buffer Supply Current	Icc	Addition for BUFFEN = HIGH		7	13	mA
Digital Input-Logic High	VIH		2			V
Digital Input-Logic Low	VIL				0.6	V
Digital Input Current (Logic-High)	IIН				5	μΑ
Digital Input Current (Logic-Low)	١L		-25			μΑ

AC ELECTRICAL CHARACTERISTICS

 $(MAX2335 EV Kit, V_{CC} = +2.9V to +3.3V, f_{LNAIN} = f_{MIXIN} = 465 MHz, f_{IF} = 110 MHz, f_{LO} = 2 \times (f_{MIXIN} + f_{IF}), 50\Omega \text{ system impedance}, \\ R_{BIAS} = 18k\Omega, R_{LNA} = 24k\Omega, \text{ cascaded performance includes 2dB interstage filter loss, } T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted}. \\ Typical values are at V_{CC} = +2.9V, P_{LO_{IN}} = -7 dBm, LOW = 0V, HIGH = +3.0V, T_A = +25^{\circ}C, \text{ unless otherwise noted}. \\ \end{array}$

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
OVERALL PERFORMANCE						
RF Frequency Range	f _{RF}			420 to 470		MHz
LO Frequency Range	fLO	After optional LO/2	MIN TYP MAX 420 to 470 500 to 660 500 to 660 - -7 -3 0 -10 -6 - 10 23.0 27 31.5 2.2 2.6 -		MHz	
IF Frequency Range	fIF			MHz		
LO Input Power		(Note 2)	-7	-3	0	dBm
LO Buffer Output Power		BUFFEN = HIGH	-10	-6		dBm
Return Loss		All modes, all active ports, including 2-element matching network, if necessary	10			dB
CASCADED PERFORMANCE						
HIGH-GAIN, HIGH-LINEARITY MO	DDE (MODE	[2:0] = 111)				
Gain	G	(Note 1)	23.0	27	31.5	dB
Noise Figure	NF	Including off-chip matching, $T_A = +25^{\circ}C$ (Note 2)		2.2	2.6	dB
Input Third-Order Intercept Point	IIP3	T _A = +25°C (Notes 1, 3)	-14	-11.5		dBm



AC ELECTRICAL CHARACTERISTICS (continued)

(MAX2335 EV Kit, V_{CC} = +2.9V to +3.3V, $f_{LNAIN} = f_{MIXIN} = 465$ MHz, $f_{IF} = 110$ MHz, $f_{LO} = 2 \times (f_{MIXIN} + f_{IF})$, 50 Ω system impedance, R_{BIAS} = 18k Ω , R_{LNA} = 24k Ω , cascaded performance includes 2dB interstage filter loss, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +2.9V, P_{LO_IN} = -7dBm, LOW = 0V, HIGH = +3.0V, T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
HIGH-GAIN, LOW-LINEARITY MO	DDE (MODE[2:0] = 101)					
Gain	G	(Note 1)	21.0	26.5	30.5	dB	
Noise Figure	NF	Including off-chip matching, $T_A = +25^{\circ}C$ (Note 2)		2.1	2.5	dB	
Input Third-Order Intercept Point	IIP3	T _A = +25°C (Notes 1, 3)	-15	-12.5		dBm	
LOW-GAIN MODE (MODE[2:0] =	011)						
Gain	G	(Note 1)	5	9	14	dB	
Noise Figure	NF	Including off-chip matching, $T_A = +25^{\circ}C$ (Note 2)		12	15	dB	
Input Third-Order Intercept Point	IIP3	T _A = +25°C (Notes 1, 3)	3	7		dBm	
LNA PERFORMANCE							
HIGH-GAIN, HIGH-LINEARITY M	ODE (MODE	[2:0] = 111)					
Gain	G _{LNA}			15.5		dB	
Noise Figure	NF _{LNA}	Including off-chip matching		1.7		dB	
Input Third-Order Intercept Point	IIP3 _{LNA}	(Note 3)		+7		dBm	
HIGH-GAIN, LOW-LINEARITY MC	DDE (MODE	2:0] = 101)					
Gain	G _{LNA}			14.5		dB	
Noise Figure	NF _{LNA}	Including off-chip matching			dB		
Input Third-Order Intercept Point	IIP3 _{LNA}	(Note 3)	+5			dBm	
LOW-GAIN MODE (MODE[2:0] =	011)	·					
Gain	G _{LNA}			-2.7		dB	
Noise Figure	NF _{LNA}	Including off-chip matching			dB		
Input Third-Order Intercept Point	IIP3 _{LNA}	(Note 3)			dBm		
MIXER PERFORMANCE							
HIGH-GAIN, HIGH-LINEARITY M	DDE (MODE	[2:0] = 111)					
Gain	GMIXER			14		dB	
Noise Figure	NFMIXER	Including off-chip matching		7		dB	
Input Third-Order Intercept Point	IIP3 _{MIXER}	(Note 3)		+2		dBm	
HIGH-GAIN, LOW-LINEARITY MC	DDE (MODE[2:0] = 101)					
Gain	GMIXER			13.5		dB	
Noise Figure	NFMIXER	Including off-chip matching		6.7		dB	
Input Third-Order Intercept Point	IIP3 _{MIXER}	(Note 3)		0		dBm	
LOW-GAIN MODE (MODE[2:0] =							
Gain	GMIXER			14		dB	
Noise Figure	NFMIXER	Including off-chip matching		7		dB	
Input Third-Order Intercept Point	IIP3 _{MIXER}	(Note 3)		+2		dBm	

Note 1: Specifications at $T_A = +25^{\circ}C$ and $+85^{\circ}C$ are guaranteed by production test. Specifications at $T_A = -40^{\circ}C$ are guaranteed by design and characterization.

Note 2: Guaranteed by design and characterization.

Note 3: Two-tone IIP3 tested at f_{RF1} = 465.9MHz and f_{RF2} = 466.7MHz at -25dBm/tone.



Typical Operating Characteristics

(MAX2335 EV Kit, V_{CC} = +2.9V, f_{LNAIN} = 465MHz, f_{IF} = 110MHz, f_{LO_IN} = 1150MHz, P_{LO_IN} = -7dBm, R_{BIAS} = 18kΩ, R_{LNA} = 24kΩ, $T_A = +25^{\circ}C$, unless otherwise noted.)



4

Pin Description

PIN	NAME	DESCRIPTION
1	DEGEN	LNA Degeneration. Connect a 1nH to 3nH inductor from DEGEN to ground.
2	R _{LNA}	LNA Bias. Connect an $18k\Omega$ to $24k\Omega$ resistor from R_{LNA} to ground. Adjust R_{LNA} to adjust the linearity of the input LNA in the HGHL mode.
3	GND	Ground. Connect to PC board ground plane using low-inductance vias.
4	LNAIN	RF Input. Requires a DC-blocking capacitor, which can be used as part of the matching network.
5	MODE0	Logic Input. See Table 1.
6	MODE1	Logic Input. See Table 1.
7	MODE2	Logic Input. See Table 1.
8, 11, 14, 18, 24, 25, 27	N.C.	No Connection. These pins are internally unconnected. Connect to the PC board ground plane.
9	L0/2	Logic Input. Drive low to disable the LO/2. Drive high to enable the LO/2.
10	LO_IN	LO Input. Internally matched to 50Ω . Requires an external DC-blocking capacitor. The LO input frequency can be internally divided by two prior to application to the mixer by driving LO/2 high.
12, 23	I.C.	Internally Connected. Leave these pins unconnected for proper operation.
13	LO_OUT	LO Buffer Output. Internally matched to 50Ω . Does not require a DC-blocking capacitor. The output frequency of the buffer is equal to the LO frequency divided by two when LO/2 is high, or the LO frequency when LO/2 is low.
15, 16, 26	V _{CC}	Power Supply. Bypass pins 16 and 26 to the PC board ground with a capacitor placed as close to the pin as possible. Do not share capacitor ground vias with other ground connections.
17	BUFFEN	LO Output Buffer Enable. Drive high to enable the LO output buffer. Drive low to disable the LO output buffer.
19, 20	IF_CDMA-, IF_CDMA+	Differential IF Output Port. Requires pullup inductors to V_{CC} , which can be used as part of the matching network.
21	R _{BIAS}	Bias Resistor Connection. Connect an $18k\Omega$ to $24k\Omega$ resistor from R_{BIAS} to ground. Adjust R_{BIAS} to adjust the linearity of the input LNA in all modes except HGHL and the mixer in all modes.
22	MIXIN	Mixer Input. Requires an external matching network
28	LNAOUT	LNA Output. Requires an external pullup inductor to V_{CC} and a DC-blocking capacitor, both of which can be used as part of the matching network.
_	EP	Exposed-Paddle Ground Connection. Solder the exposed paddle (EP) evenly to the board's ground plane for proper operation.

MAX2335

_Detailed Description

Low-Noise Amplifiers (LNAs)

The MAX2335's LNA gain and linearity characteristics can be adjusted using the MODE[2:0] inputs. See Table 1 for the pin settings for various operating modes. Use high-gain, high-linearity mode (HGHL) when extra-high linearity is required for cross-modulation suppression in the presence of strong interfering signals (e.g., when the system transmitter is on). Use high-gain, low-linearity mode (HGLL) when the transmitter is off and cross-modulation is not a concern, and use low-gain mode (LG) when receiving large signals. RLNA can be adjusted to vary the current and linearity of the HGHL LNA. RBIAS adjusts the current and the linearity of the HGLL and LG LNA.

Downconverter

The mixer requires a DC-blocking capacitor at the input and pullup inductors at the output. The DC-blocking capacitors and pullup inductors can be designed to be part of the matching circuits. See Table 1 for the MODE settings for various operating modes.

LO Output Buffer

The LO output buffer is internally matched to 50Ω and includes a DC-blocking capacitor. Enable the buffer by driving the BUFFEN input high; disable the buffer by driving the BUFFEN input low. The frequency of the buffer output is equal to the LO frequency if the LO/2 input is driven low, or equal to the LO frequency divided by two if LO/2 is driven high.

Applications Information

Cascaded LNA/Mixer Performance

The LNA and mixer design optimizes cascaded performance in all gain and linearity modes. In HGHL mode, both the LNA and mixer have a low noise figure, high gain, and high linearity. The LNA has high gain to minimize the noise contribution of the mixer, thus increasing the receiver's sensitivity, and the LNA has high linearity for cross-modulation suppression. The HGLL mode is used when the transmitter is off and cross-modulation is not a concern. In LG mode, the received signal is strong enough that linearity is the primary concern. The LNA gain is reduced to achieve higher system linearity.

S-Parameters

The S-parameters in Tables 2, 3, and 4 can be used to design the RF matching circuits.

					CONTROL PINS						
MODES	LO/1	L0/2	HGHL LNA	HGLL LNA	LG LNA	HGHL MIXER	HGLL MIXER	MODE2	MODE1	MODE0	LO/2
HGHL (LO Frequency Divided by Two)		1	1			1		1	1	1	1
HGLL (LO Frequency Divided by Two)		1		1			1	1	0	1	1
LG (LO Frequency Divided by Two)		~			~	~		0	1	1	1
HGHL (LO Frequency Undivided)	1		>			1		1	1	1	0
HGLL (LO Frequency Undivided)	1			1			1	1	0	1	0
LG (LO Frequency Undivided)	1				1	1		0	1	1	0
Shutdown Mode								0	0	0	Х
Undefined								1	Х	0	Х
Undefined								Х	1	0	Х

Table 1. Operating Modes

FREQUENCY (MHz)	S11 (dB)	∠S11 (DEGREES)	S21 (dB)	∠S21 (DEGREES)	S12 (dB)	∠S12 (DEGREES)	S22 (dB)	∠S22 (DEGREES)
50	-0.693	-20.000	22.265	2.173	-45.196	-39.133	-0.607	55.183
100	-1.302	-38.600	21.655	-41.256	-37.836	-83.956	-0.532	10.563
150	-1.957	-54.244	20.037	-68.340	-33.411	-107.964	-0.819	-11.252
200	-2.407	-68.840	18.300	-89.560	-31.340	-124.383	-1.051	-26.637
250	-2.656	-82.550	16.860	-105.680	-29.466	-136.021	-1.250	-39.640
300	-2.813	-97.830	15.354	-120.500	-28.422	-147.784	-1.420	-51.424
350	-2.959	-112.274	14.262	-133.400	-26.605	-161.620	-1.492	-63.020
400	-2.953	-127.226	12.926	-144.921	-25.600	-172.633	-1.590	-73.860
410	-2.944	-130.500	12.710	-146.900	-25.519	-174.766	-1.630	-76.200
420	-2.914	-133.724	12.530	-149.125	-25.062	-177.340	-1.628	-78.540
430	-2.876	-136.800	12.439	-151.380	-24.960	-179.138	-1.634	-80.612
440	-2.878	-139.320	12.220	-153.900	-24.780	177.020	-1.650	-82.870
450	-2.884	-142.833	12.000	-155.650	-24.500	176.320	-1.665	-84.900
460	-2.850	-145.863	11.820	-158.324	-24.465	173.850	-1.667	-87.422
470	-2.828	-149.000	11.550	-160.300	-24.239	171.027	-1.697	-89.183
480	-2.828	-159.962	11.343	-161.928	-24.180	169.065	-1.711	-91.480
490	-2.811	-155.360	11.150	-163.540	-23.736	167.483	-1.720	-93.335
500	-2.763	-158.386	11.060	-165.000	-23.568	164.144	-1.718	-95.970
550	-2.628	-174.012	10.298	-174.600	-22.850	152.660	-1.756	-107.020
600	-2.444	169.970	9.810	178.350	-21.890	139.530	-1.770	-117.930
650	-2.230	153.600	9.255	170.400	-21.400	128.572	-1.778	-129.730
700	-1.989	137.420	9.200	162.304	-20.375	117.290	-1.776	-141.100
750	-1.733	121.170	9.164	154.522	-20.230	106.200	-1.828	-152.555
800	-1.464	104.500	9.470	146.813	-19.626	94.020	-1.778	-164.610
850	-1.236	87.855	9.690	135.700	-19.430	83.711	-1.810	-176.805
900	-0.978	73.488	10.432	127.430	-18.654	70.714	-1.860	170.521
950	-0.889	53.876	10.613	112.950	-18.512	59.976	-1.887	158.326
1000	-0.858	36.186	11.417	101.010	-17.839	45.167	-2.033	145.377

Table 2. MAX2335 LNA S-Parameters in HGHL Mode

Power-Supply Layout

To minimize coupling between different sections of the IC, use a star configuration, which has a large decoupling capacitor at a central V_{CC} node. The V_{CC} traces branch out from this node, each going to a separate V_{CC} pin of the MAX2335. At the end of each trace is a bypass capacitor with impedance to ground less than 1 Ω at the frequency of interest. This arrangement provides local decoupling at each V_{CC} pin. Use at least one via per bypass capacitor for a low-inductance ground connection. Also, connect the exposed paddle to the PC board GND with multiple vias to provide the lowest inductance ground connection possible.

Table 3. MAX2335 Mixer Input Impedancein HGHL Mode

FREQUENCY (MHz)	S11 (dB)	∠S11 (DEGREES)
400	-1.2	77.23
410	-1.229	74.52
420	-1.247	71.7
430	-1.24	69.124
440	-1.24	66.47
450	-1.25	63.97
460	-1.28	61.455
470	-1.32	58.68
480	-1.33	55.87
490	-1.35	53.565
500	-1.35	50.87

Matching Network Layout

The layout of a matching network can be very sensitive to parasitic circuit elements. To minimize parasitic inductance, keep all traces short and place components as close to the IC as possible.

Use high-Q components for the LNA input-matching network to achieve the lowest possible noise figure. Keep the distance between the differential signal lines at the mixer outputs constant and make both lines of equal length to ensure signal balance.

_Chip Information

PROCESS: SiGe

IF FREQUENCY (MHz)	EQUIVALENT SHUNT RESISTANCE (kΩ)	EQUIVALENT SHUNT CAPACITANCE (pF)
80	17.7	1.21
100	16.961	1.21
120	15.79	1.21
140	14.616	1.21
160	13.49	1.21
190	11.87	1.21

Table 4. MAX2335 Mixer OutputImpedance (Shunt RC) in HGHL Mode

Typical Application Circuit



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



MAX2335

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

Г

			COMN	ION DI	MEN	SION	S									EX	POSEI	D PAD	VARI	ATION	S		
PKG.	16	5x5		20L 5x	5	2	8L 5x	5	3	2L 5x	(5	40L 5x5		5	PKG.		D2			E2	Exceptions	DOWN	
SYMBOL	MIN. N	IOM. MA	X. MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	CODES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	±0.15	BONDS ALLOWE
А	0.70	0.75 0.8	0 0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	T1655-2	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
A1	0 0	0.02 0.0	5 0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	T1655-3	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
A3	0.2	REF.	0	.20 RE	F.	0.	20 RE	F.	0.	20 RE	F.	0.	20 RE	F.	T1655N-1	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
b		.30 0.3													T2055-3	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
D		5.00 5. ⁻	_												T2055-4	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
E		5.00 5. ⁻													T2055-5	3.15	3.25	3.35		3.25	3.35	0.40	YES
e		0 BSC.	_).65 BS	-		.50 BS			.50 BS	SC.		.40 BS		T2855-3	3.15	3.25	3.35	3.15	3.25	3.35	**	YES
k	0.25		0.25	+ +	-	0.25		-	0.25	-	-		0.35		T2855-4	2.60		2.80		2.70	2.80	**	YES
L L1	0.30 0		0 0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.40	0.50		T2855-5	2.60	2.70	2.80	2.60	2.70	2.80	**	NO
N	-	- - 16	-	20	-	-	- 28	-	-	32	-	0.30	40	0.50	T2855-6	3.15	3.25	3.35	3.15	3.25	3.35	**	NO
ND		4		<u>20</u> 5			<u>20</u> 7			<u> </u>			10	_	T2855-7	2.60	2.70	2.80	2.60	2.70	2.80	**	YES
NE		4	-	5			7			8			10		T2855-8	3.15	3.25	3.35	3.15	3.25	3.35	0.40	YES
JEDEC	W	'HHB		WHHC		V	VHHD	-1	v	VHHD	-2				T2855N-1	3.15	3.25	3.35	3.15	3.25	3.35	**	NO
															T3255-3	3.00	3.10	3.20	3.00	3.10	.20	**	YES
OTES:															T3255-4	3.00	3.10	3.20	3 .00	3.10	.20	**	NO
1. DIM	IENSIO	VING &	TOLER		G C O	NFOF	м то	ASM	E Y14	.5M-19	994.				T3255-5	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
2. ALL															T3255N-1	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
3. N IS											0.				T4055-1	3.20	3.30	3.40	3.20	3.30	3.40	**	YES
	E TERM NFORM FIONAL NTIFIEF IENSIOI	TO JES BUT M MAY E N b APF	D 95-1 UST BE E EITH LIES T(SPP-0 ² LOCA ER A M D META	I2. D TED IOLD	ETAIL WITH OR M ED TE	_S OF IN THE 1ARKE ERMIN	TERN E ZON ED FE	AINAL NE INE ATUR	#1 ID DICATI E.	ENTII ED. T	FIER / HE TE	ARE ERMIN	AL #1									
A ND	and ne	REFE	R TO TH	IE NUN	1BER	OF T	ERMI	NALS	ON E	ACH E) ANE	DESI	DE RE	SPECTI	ELY.								
7. DEF	POPULA	TION IS	POSS	IBLE IN	I A S	YMME	TRIC	AL FA	SHIO	N.													
<u>∕</u> ®∖ co⊧	PLANAF	RITY AP	PLIES	TO THE	EXP	OSEE	HEA	T SIN	K SLU	IG AS	WELI	L AS 1	THE T	RMINAL	S.								
9. DRA T28	AWING 55-3 AN) JEDE	СМС	0220,	EXCE	PT E>	KPOSI	ED PA	D DIN	MENS	ION F	DR									
🕰 wai	RPAGE	SHALL	NOT E	KCEED	0.10	mm.										Γ.				_	_		
44	RKING I	S FOR	PACKA	GE ORI	ENT	ATION	REFE	EREN	CE OI	NLY.							₽₽₽	ALL			1/	X	
TT. MAN	MBER C	F LEAD	S SHO	WN AR	E FO	R REI	EREN	NCE C	ONLY.							ľ	J JE	mooriu	OUTOR				
12. NUN			ES TO E	BE AT 1	RUE	POS	ITION	AS DI	EFINE	D BY	BASI	C DIM	IENSI	N "e", ±	0.05.				GE OUT				
	D CEN															I	1	6, 20, 2			N QFN	5x5x0.8	Bmm

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600 ___

© 2005 Maxim Integrated Products Printed USA MAXIM is a registered trademark of Maxim Integrated Products, Inc.

٦